

End-of-Sector Boxes Update

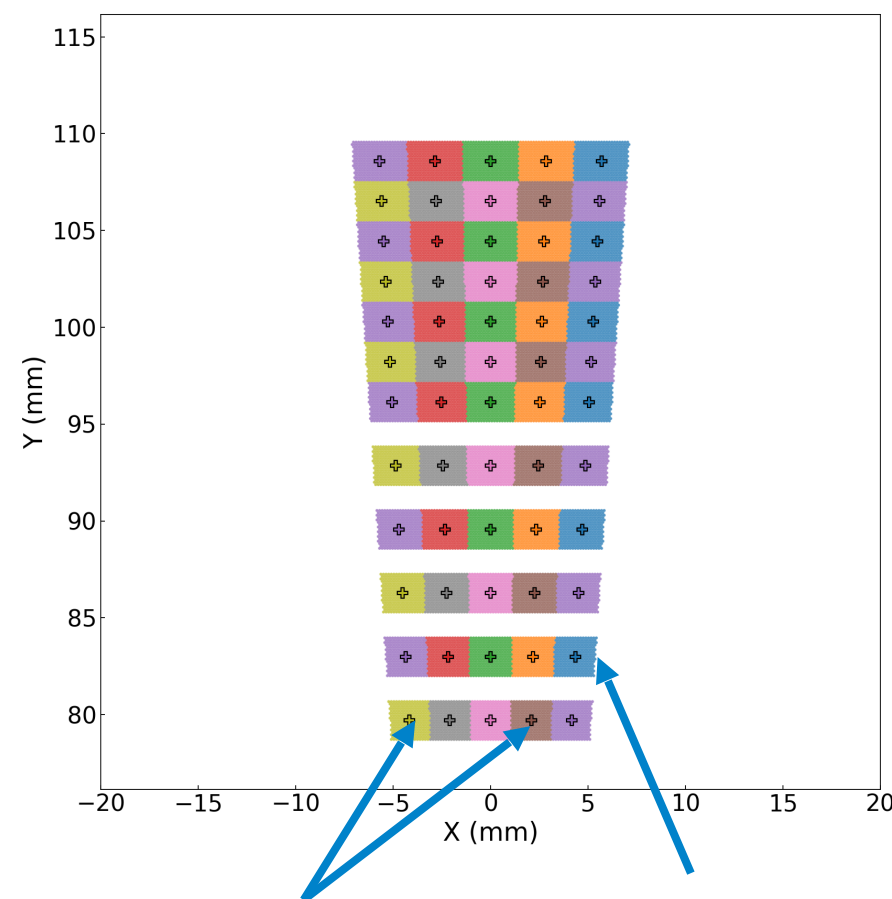
ePIC/Barrel Imaging Calorimeter

Z. Papandreou
BIC General Meeting
March 1, 2024

SiPM Readout

- **2-sided SiPM readout**
- **Lightguides** on sector sides
 - inner surface $\sim 2 \times 2 \text{ cm}^2$
 - output face $1.3 \times 1.3 \text{ cm}^2$
- SiPMs that meet our requirements:
 - 4 x $6 \times 6 \text{ mm}^2$ SiPMs with $50 \mu\text{m}$ pixels (e.g. 4 x S14160-6050, or a **pre-assembled S14161-3050-04 array**)
- 12 layers x 5 cells x 2 sides x 48 sectors = **5760 channels**

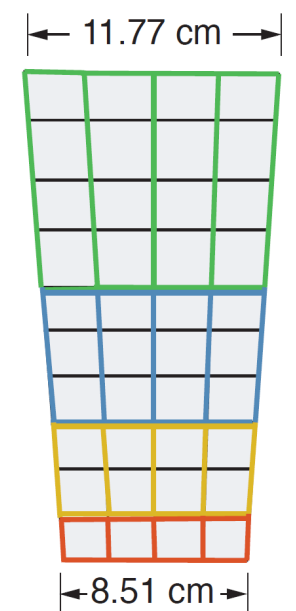
ePIC Sector End View
(x-y plane view), 17.1 X0



Readout Cell
Has lightguide
Layer = 5 cells

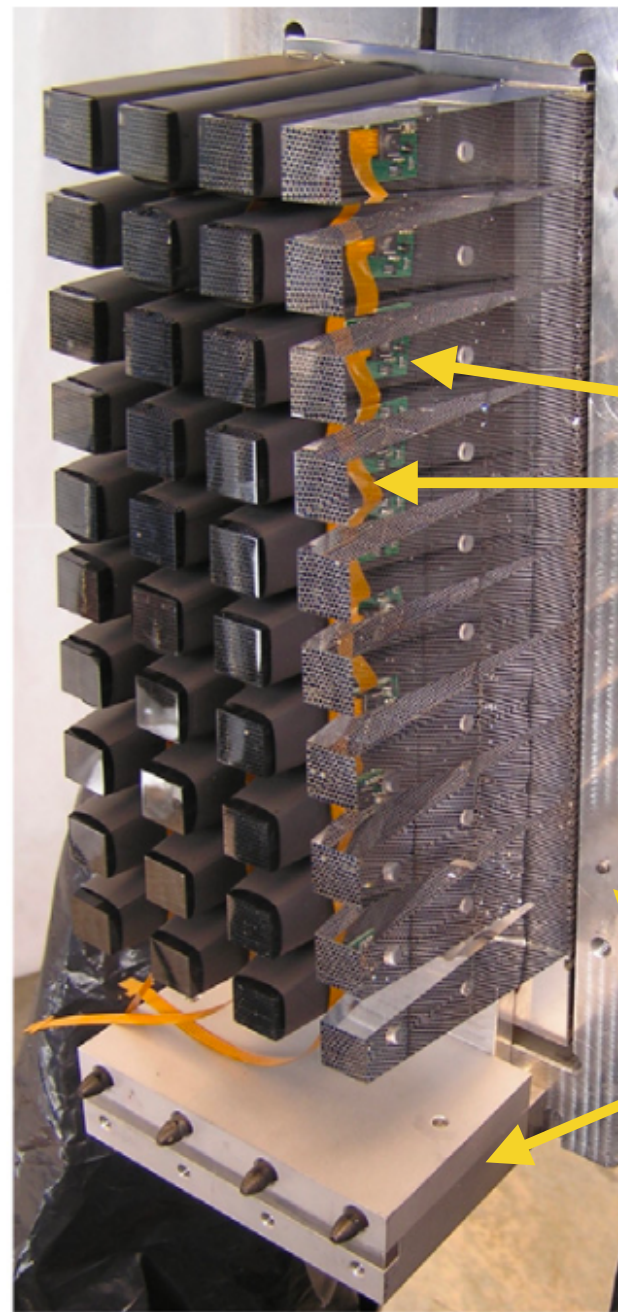
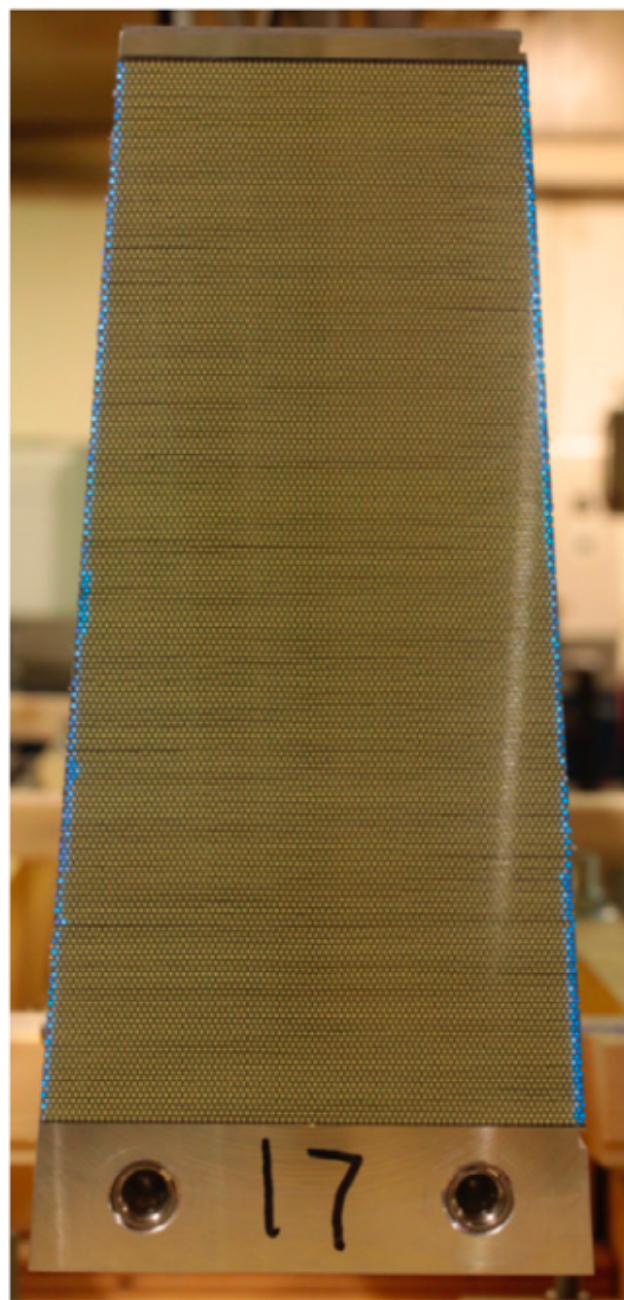
Pb/SciFi Layer
1 sector = 12 layers
1 layer = 17 fiber rows

GlueX Sector End View, 15.5 X0



Hamamatsu
S12045(X)
4x4 array of $3 \times 3 \text{ mm}^2$
 $50 \times 50 \mu\text{m}^2$ pixels
16 FADC per side
12 TDC per side

GLUEX BCAL Light Guides



LED mini boards;
Flex cable

LG mounting jig

GLUEX BCAL Light Guides

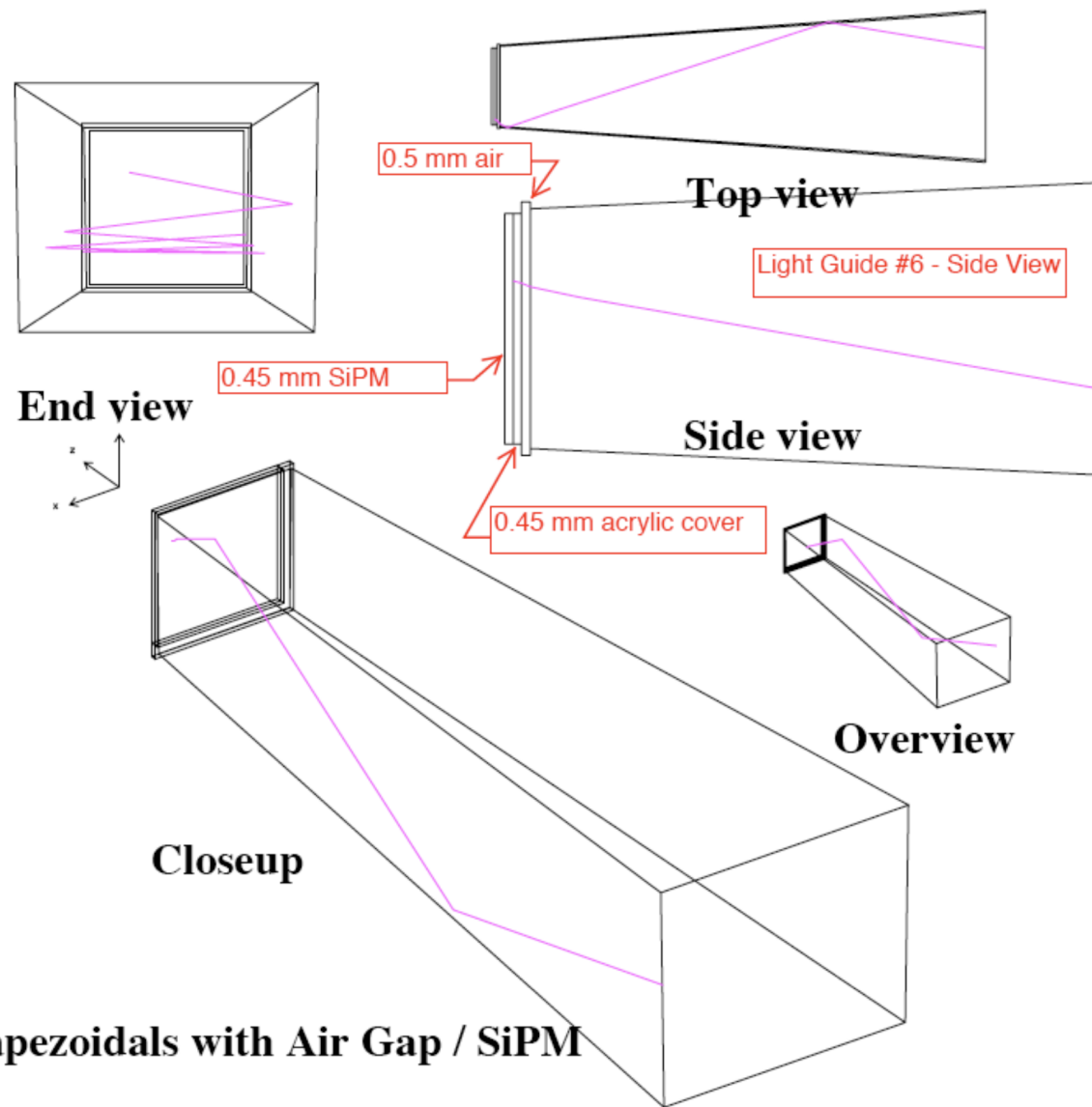
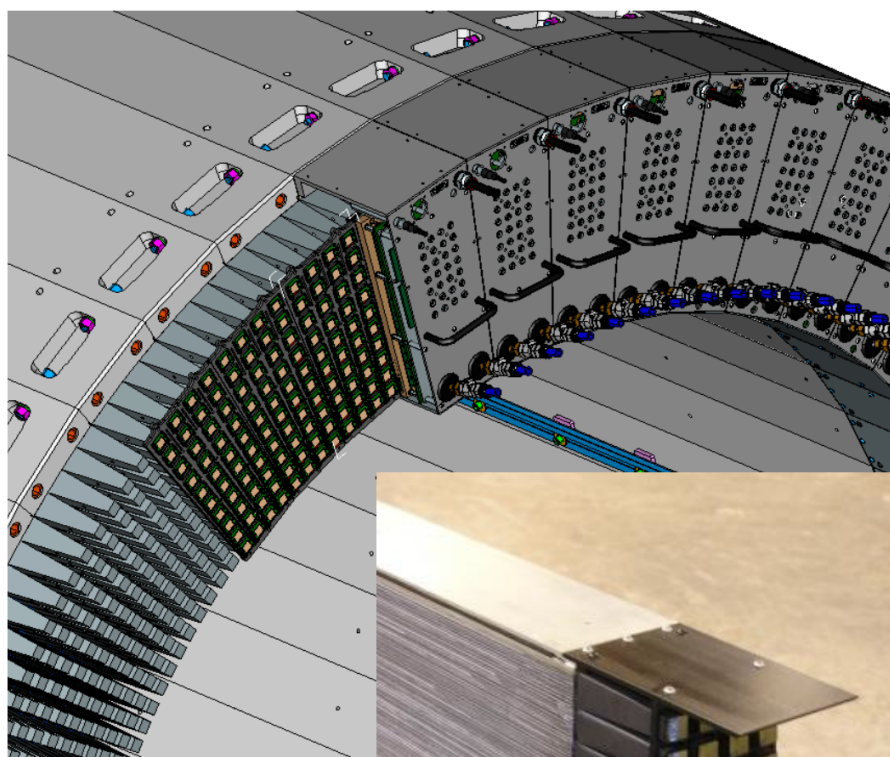


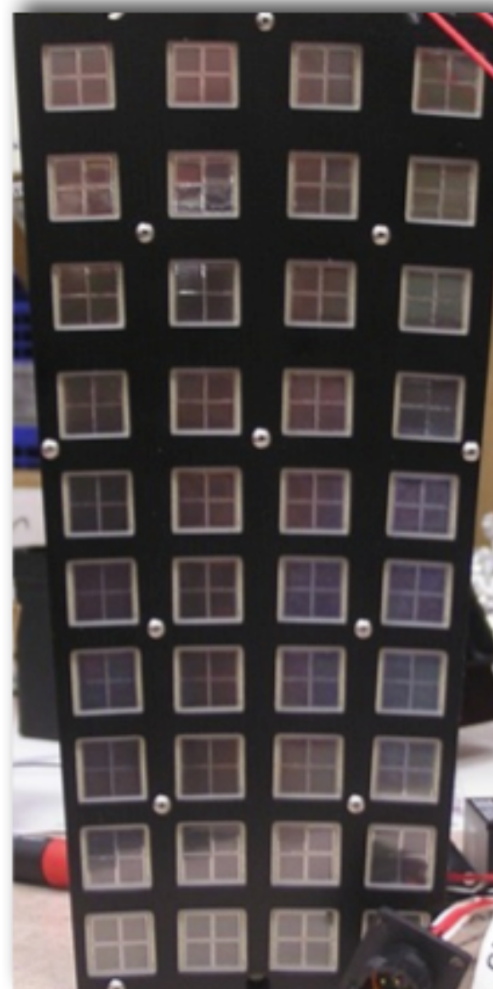
Table 1: Sizes of the ten production light guides for the Bcal. The trapezoid dimensions are denoted using the notation (bottom-top $\times$ height).

Configuration	Input Trapezoid (mm ²)	Length (cm)	Output Trapezoid (mm ²)	Eff (%)
g1	20.96-21.64 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.748
g2	21.64-22.30 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.723
g3	22.30-22.99 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.701
g4	22.99-23.65 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.683
g5	23.67-24.33 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.662
g6	24.33-25.02 $\times$ 20.57	8	13.19-13.61 $\times$ 13.19	0.643
g7	25.02-25.83 $\times$ 24.64	8	13.19-13.61 $\times$ 13.19	0.516
g8	25.83-26.62 $\times$ 24.64	8	13.19-13.61 $\times$ 13.19	0.503
g9	26.64-27.43 $\times$ 24.64	8	13.19-13.61 $\times$ 13.19	0.488
g10	27.46-27.84 $\times$ 24.64	8	13.19-13.61 $\times$ 13.19	0.477

BCAL SiPMs



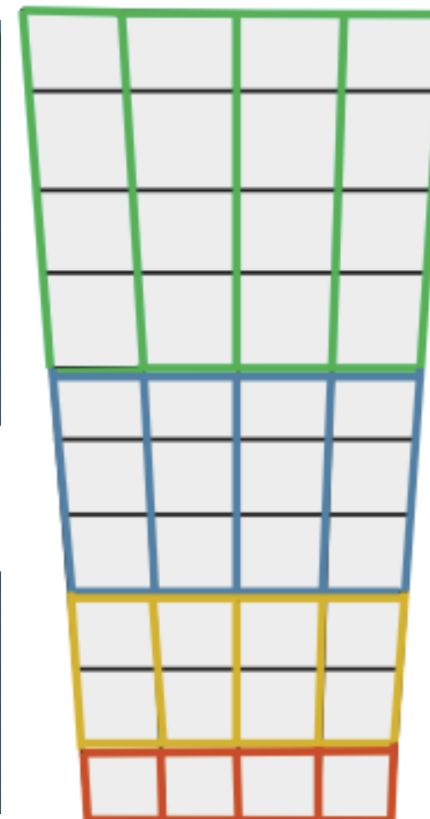
Light
guides



Assembly



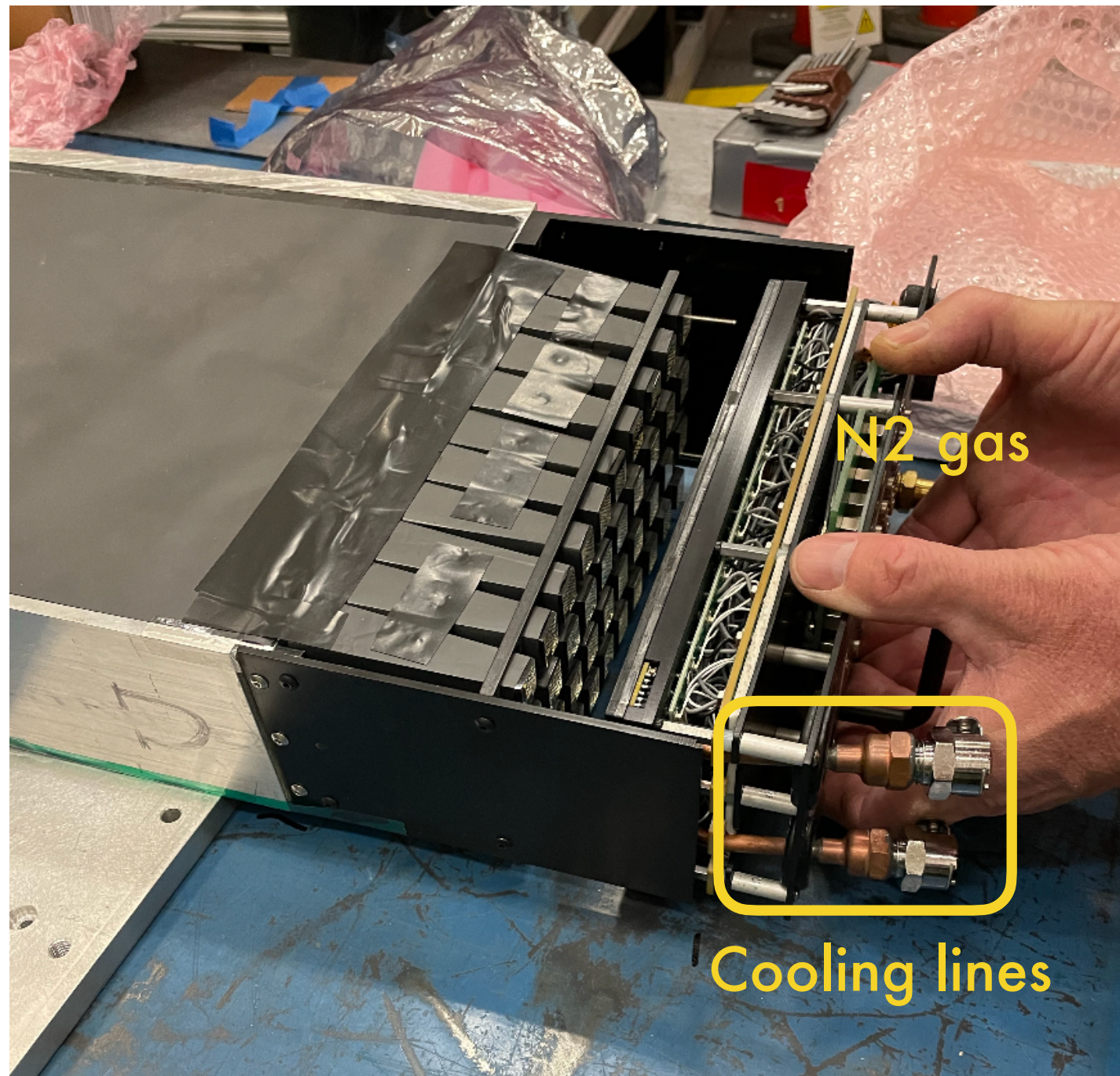
Electronics



Summing
Scheme

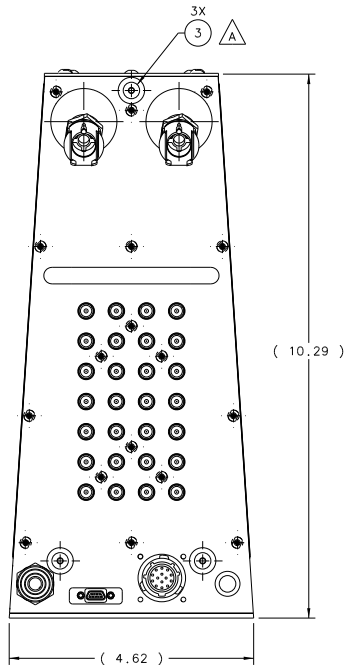
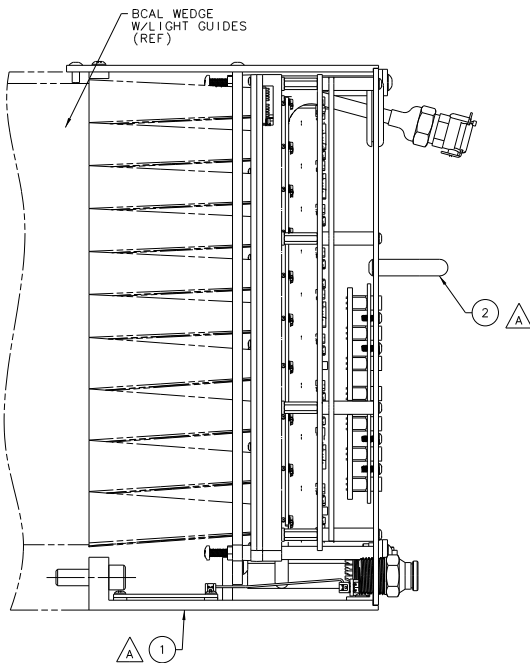
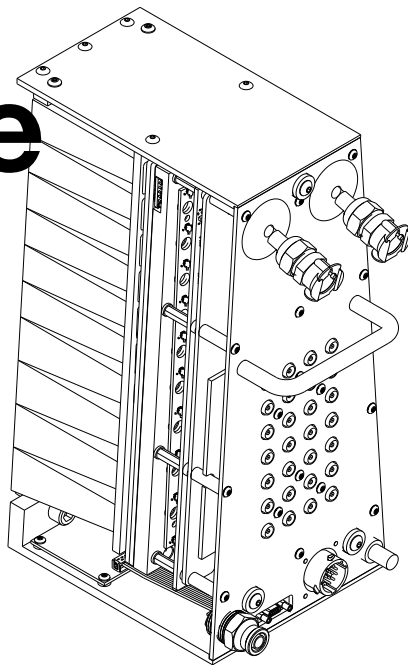
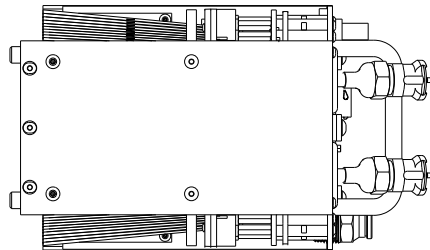
GlueX: discrete electronics; Norbert's HGCROC for BIC modern approach

BCAL "Wedges"



- Contiguous LG stacking
- LG-SiPM air gap
- BIC: Si cookie
- Spring loading
- Integrated ESB for installation ease

GlueX-BCAL Wedge



REVISION HISTORY				
ZONE	REV	DESCRIPTION	DATE	APPROVED
6C, 7B, 3E, 3B	A	UPDATED ITEMS 1 & 2. ITEM 3 WAS SPACER. DELETED ITEMS 4-6 & NOTE 1. DRAWING NAME WAS READOUT MODULE - O GROOVE	04AUG14	R GETZ WHITLATCH

(A)	3	3	D00000-01-07-2097	BCAL STANDOFF ASSY		
	1	2	D00000-01-07-1023	COOLING/ELEC MODULE		
	1	1	D00000-01-07-1016	CAGE ASSY W/OUT GROOVE		
QTY		ITEM NO.	PART OR IDENTIFYING NO.	MANUFACTURE OR DESCRIPTION	MATERIAL SPECIFICATION	NOTES
PARTS LIST						
EACH SHEET OF MULTI-SHEET DRAWINGS SHALL ALWAYS HAVE THE SAME REVISION LEVEL.						
DRAWING CONTROL STAMP UNLESS OTHERWISE SPECIFIED REMOVE A BREAK ALL SHARP EDGES DO NOT SCALE DRAWING		TRACKING NO. N/A		United States Department of Energy	Jefferson Lab HALL D - GLUEX DETECTOR BARREL CALORIMETER READOUT MODULE ASSY	
		APPROVALS		DATE	REV. A	
DRAWING	THIRD ANGLE PROJECTION		DRAWN: C. L. HUTTON		01NOV10	
			CHECKED: J. FOOTMAN		25MAR11	
			APPROVED: J. FOOTMAN		25MAR11	
			APPROVED: T. WHITLATCH		20MAR11	
		SIZE (DWG. NO.)		E D00000-01-07-1011		REV. A
		SCALE 1:1		SHEET 1 OF 1		

REVISION HISTORY				
ZONE	REV	DESCRIPTION	DATE	APPROVED
VAR	A	COMPLETE REDESIGN	CLH 18JAN13	

NOTES:

1. SUGGESTED SOURCE OR JLAB APPROVED ALTERNATE

DIGI-KEY CORPORATION
1-800-344-4539
www.digikey.com

ALLIED ELECTRONICS
(866) 433-5722
WWW.ALLIEDELEC.COM

MCMaster-CARR
1-630-833-0300
www.mcmaster.com

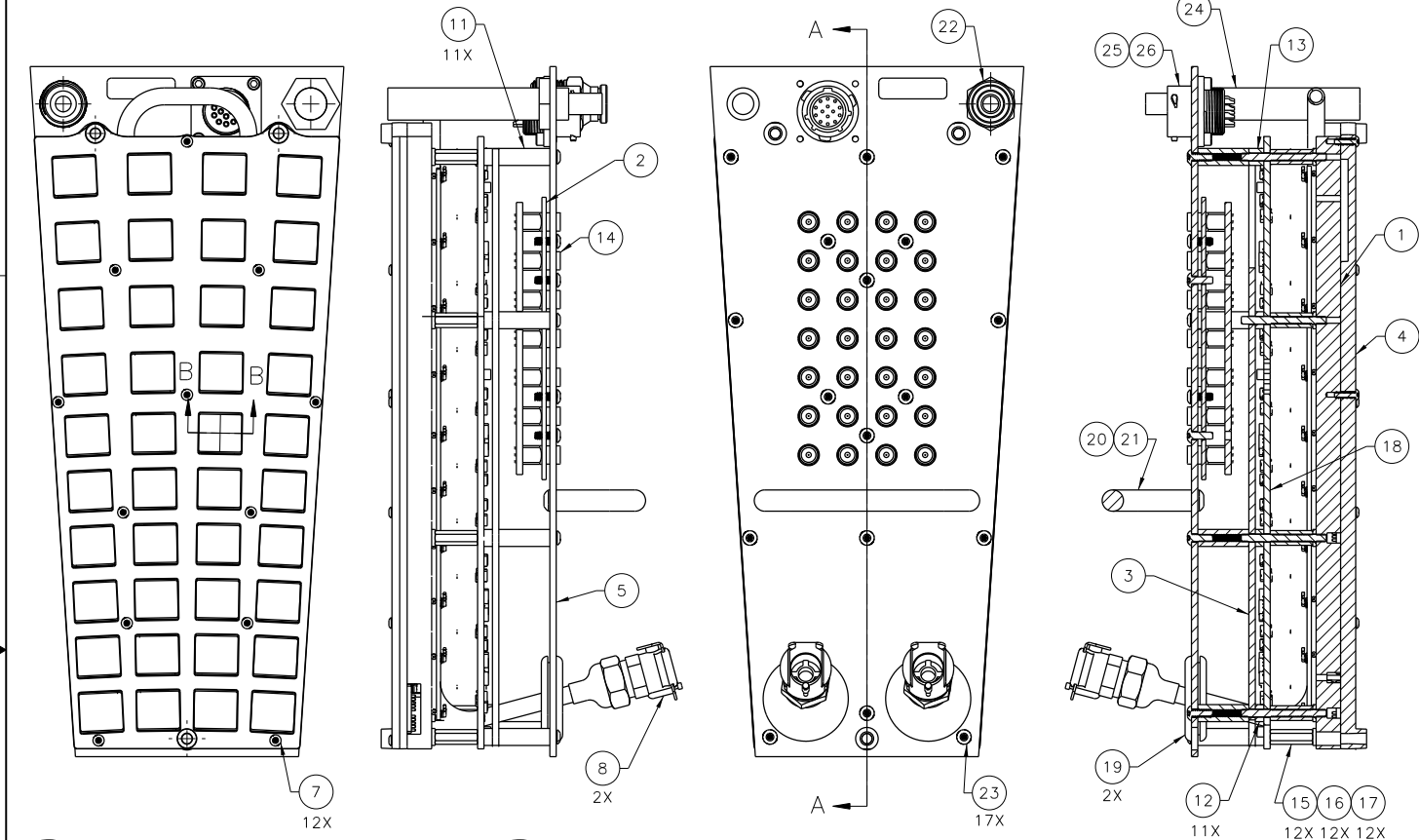
MICHELL INSTRUMENTS UK
(44) 01353 658000
www.michell.com

2. ITEMS 22 AND 24 ONLY USED AS NEEDED. WHEN NOT USED, HOLES IN COVER WILL BE PLUGGED.

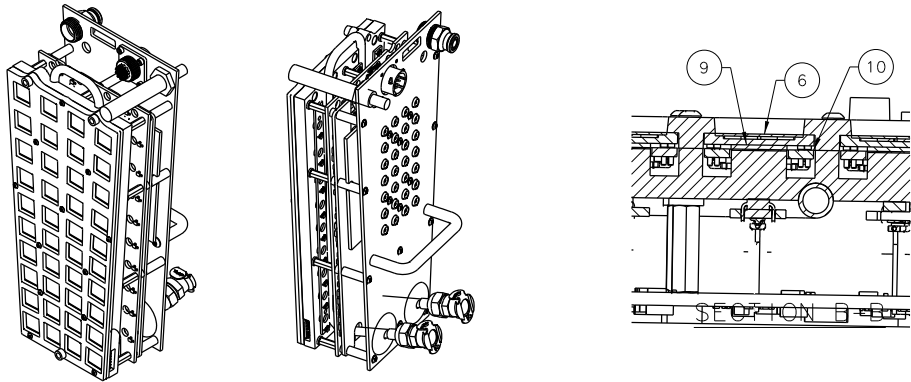
4	26	MCMaster-CARR #92196A105	HEX HD CAP SCREW #4-40 X .18 LG	18-8 SS	1
1	25	ALLIED ELECTRONICS 70129601	SO FLANGE RECEPTACLE W/14 PIN CONTACTS (SOURIAU #UTS012E14P)		1
1	24	MICHELL INSTRUMENTS PCMINI-52	HUMIDITY AND TEMP MINI PROBE		1 & 2
17	23	MCMaster-CARR #92949A107	BUTTON HD CAP SCREW #4-40 X .31 LG	18-8 SS	1
1	22	MCMaster-CARR #51915K140	PUSH-TO-CONNECT ADAPTER FOR 3/8" TUBE OD X 3/8" NPTF MALE PIPE	VARIOUS	1 & 2
2	21	MCMaster-CARR #93310A194	BUTTON HD SOC HD CAP SCREWMET #8-32 X 1/2" LG SELF LOCKING	18-8 SS	1
1	20	MCMaster-CARR #1568A43	ROUND-GRIP PULL HANDLE 3" CTR TO CTR	ALUMINUM	1
2	19	MCMaster-CARR #9307K76	PUSH-N FLEXIBLE GROMMET 1/4" ID, 1-1/4 OD	RUBBER	1
1	18		AMPLIFIER AND SIGNAL PCB		
12	17	MCMaster-CARR #90295A346	FLAT WASHER, BLACK #4 SCREW SIZE, .25 OD	NYLON 6/6	1
12	16	MCMaster-CARR #91115A518	FEMALE HEX STANDOFF, 4-40 3/16 HEX, 5/8 LONG	18-8 SS	1
12	15	MCMaster-CARR #95412A360	THREADED STUD, FULL THREAD 4-40 X 1.25 LG	18-8 SS	1
1	14		INTERCONNECT PCB ASSEMBLY		
1	13	MCMaster-CARR #94639A486	SPACER, #4 UNTHREADED 1/4" OD X 7/32 LG	NYLON	1
11	12	MCMaster-CARR #94639A199	SPACER, #4 UNTHREADED 1/4" OD X 1/8 LG	NYLON	1
11	11	MCMaster-CARR #93330A437	STANDOFF, #4-40 FEMALE 1/4" OD X 3/4 LG	ALUMINUM	1
40	10		FERNANDOS C-BOARD		
40	9	DIGIKEY CORP 3M9593-ND	THERMAL PAD, 3M 5519/0.5mm THICK	SILICONE	1
2	8	MCMaster-CARR #5012K75	QUICK DIS-CONNECT COUPLING 1/4" MALENPT W/VALVE	ACETAL	1
12	7	MCMaster-CARR #92949A078	BUTTON HD CAP SCREW #2-56 X .31 LG	18-8 SS	1
40	6	HAMAMATSU PHOTONICS K30-F10530	HAMAMATSU SiPM LIGHT SENSOR S10943-0258(X) MPPC ARRAY		
1	5	D00000-01-07-2067	READOUT MODULE COVER PLATE		
1	4	D00000-01-07-2070	SINGLE RADIAL SiPM HOLDER		
1	3	D00000-01-07-2068	HEAT TRANSFER PLATE		
1	2	D00000-01-07-2068	INTERCONNECT PULL PLATE		
1	1	D00000-01-07-1021	COOLING PLATE ASSY		

QTY	ITEM	PART OR IDENTIFYING NO.	NOMENCLATURE OR DESCRIPTION	MATERIAL SPECIFICATION	NOTES
PARTS LIST					
DOCUMENT CONTROL STAMP			TRACKING NO. N/A	United States Department of Energy	Jefferson Lab Central Research and Development Facility Newport News Virginia
MATERIAL SEE PARTS LIST			APPROVALS	DATE	
FINISH 125 UNLESS OTHERWISE NOTED DEBURR & BREAK ALL SHARP EDGES			CHECKED J FOCHTMAN	21MAR11	
DO NOT SCALE DRAWING			APPROVED J FOCHTMAN	25MAR11	
			APPROVED T WHITLATCH	28MAR11	
			DRAWN C L HUTTON	21MAR11	
			CHECKED J FOCHTMAN	25MAR11	
			APPROVED J FOCHTMAN	25MAR11	
			APPROVED T WHITLATCH	28MAR11	
			SIZE DWG. NO. D	000000-01-07-1023	REV. A
			SCALE 1:1	ISS IN KOP NO. 000000-01-07-1011	SHEET 1 OF 1

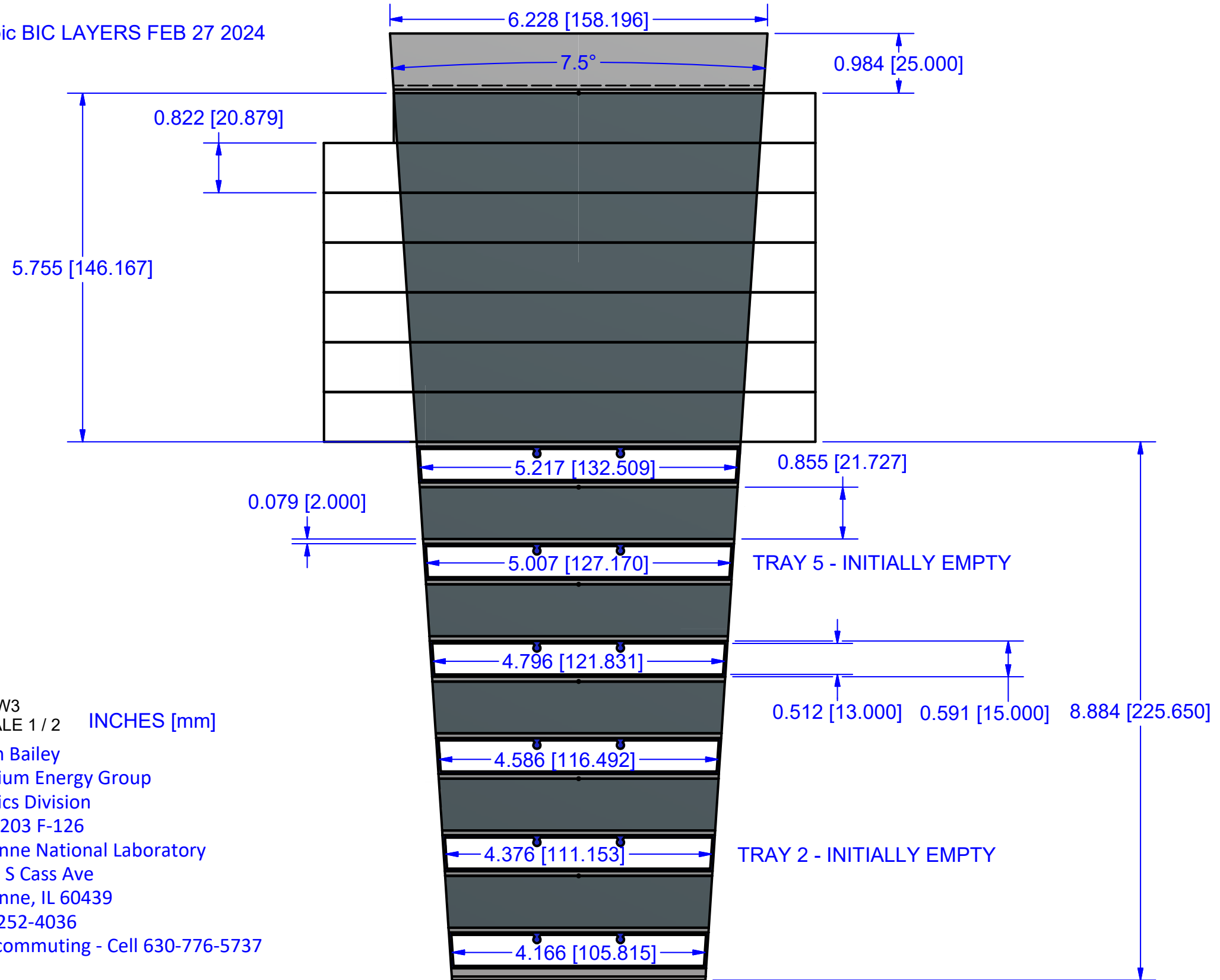
Approved: 01/23/2013; E-Sign ID: 225000; Signed By: Approver 1: T. Whitlatch; Checker: J. Fochtmann; DCG: T. Fuel



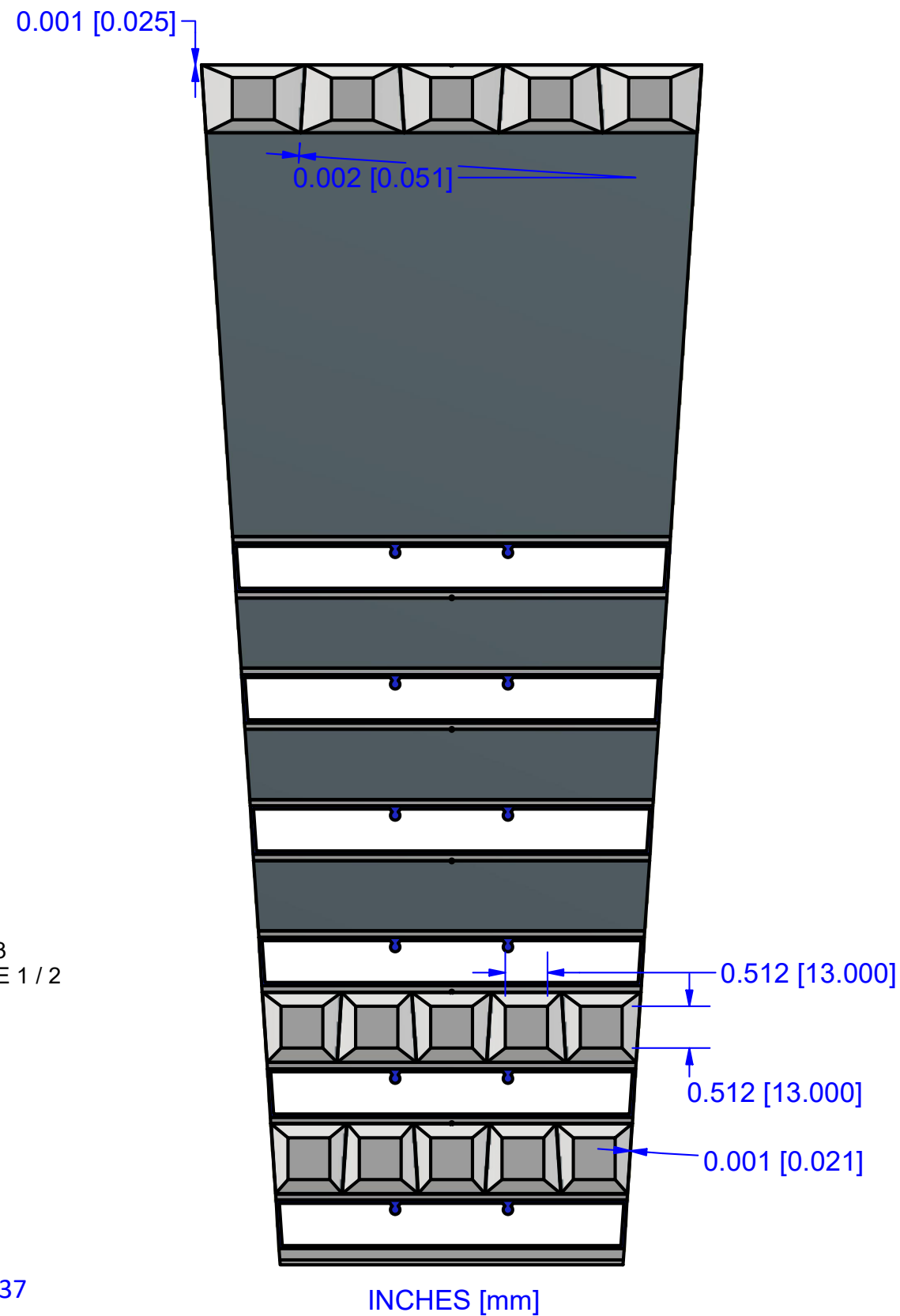
GlueX-BCAL Wedge



Epic BIC LAYERS FEB 27 2024

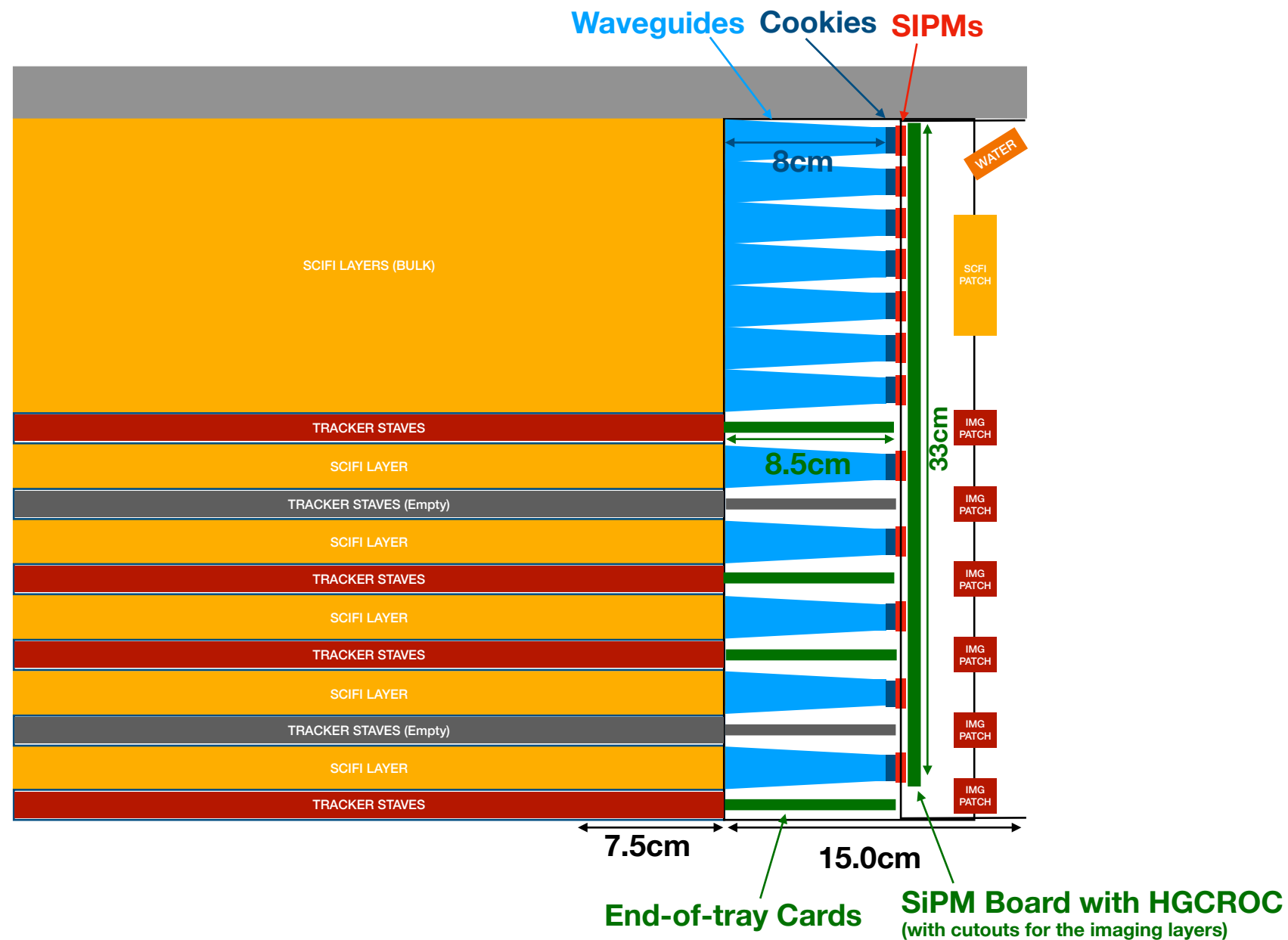


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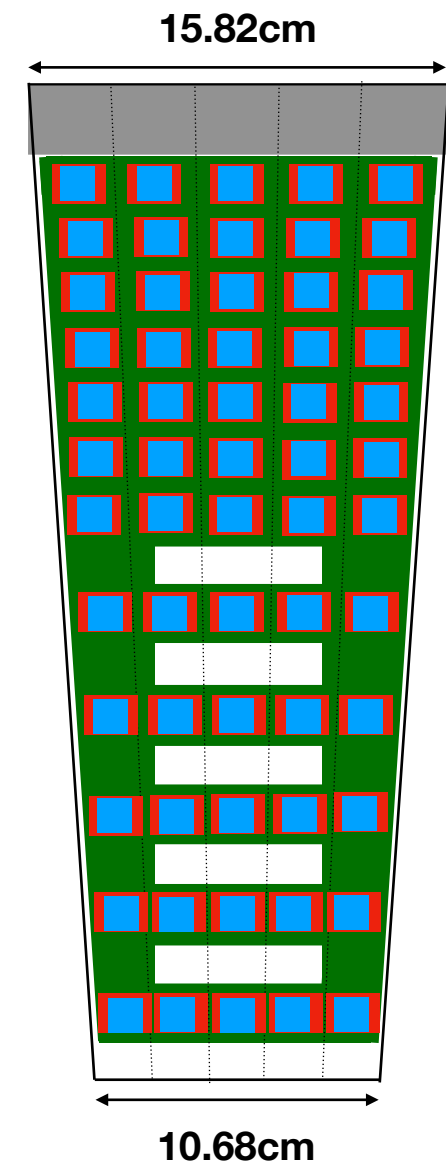


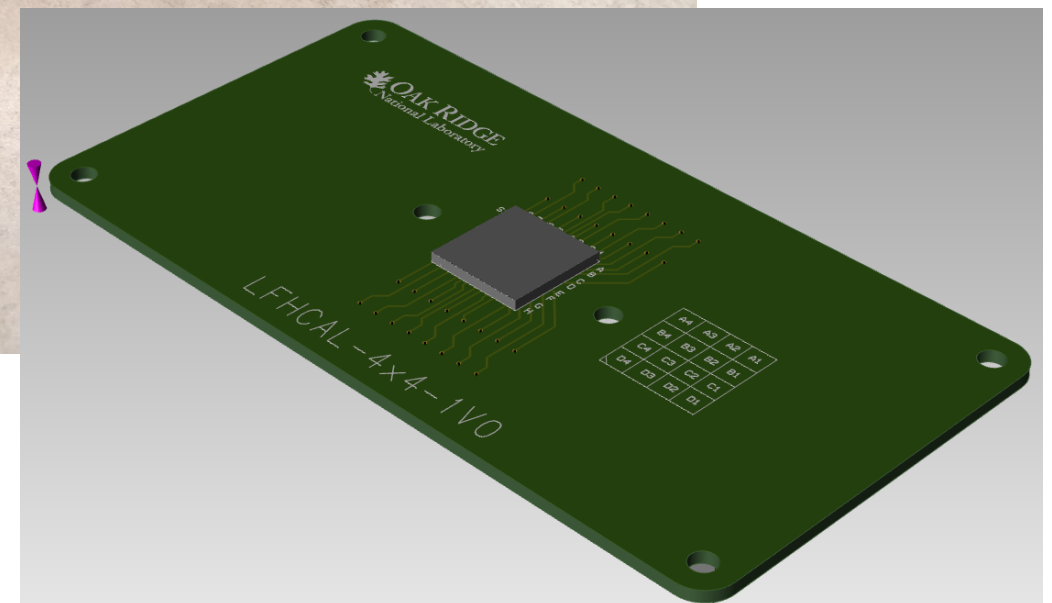
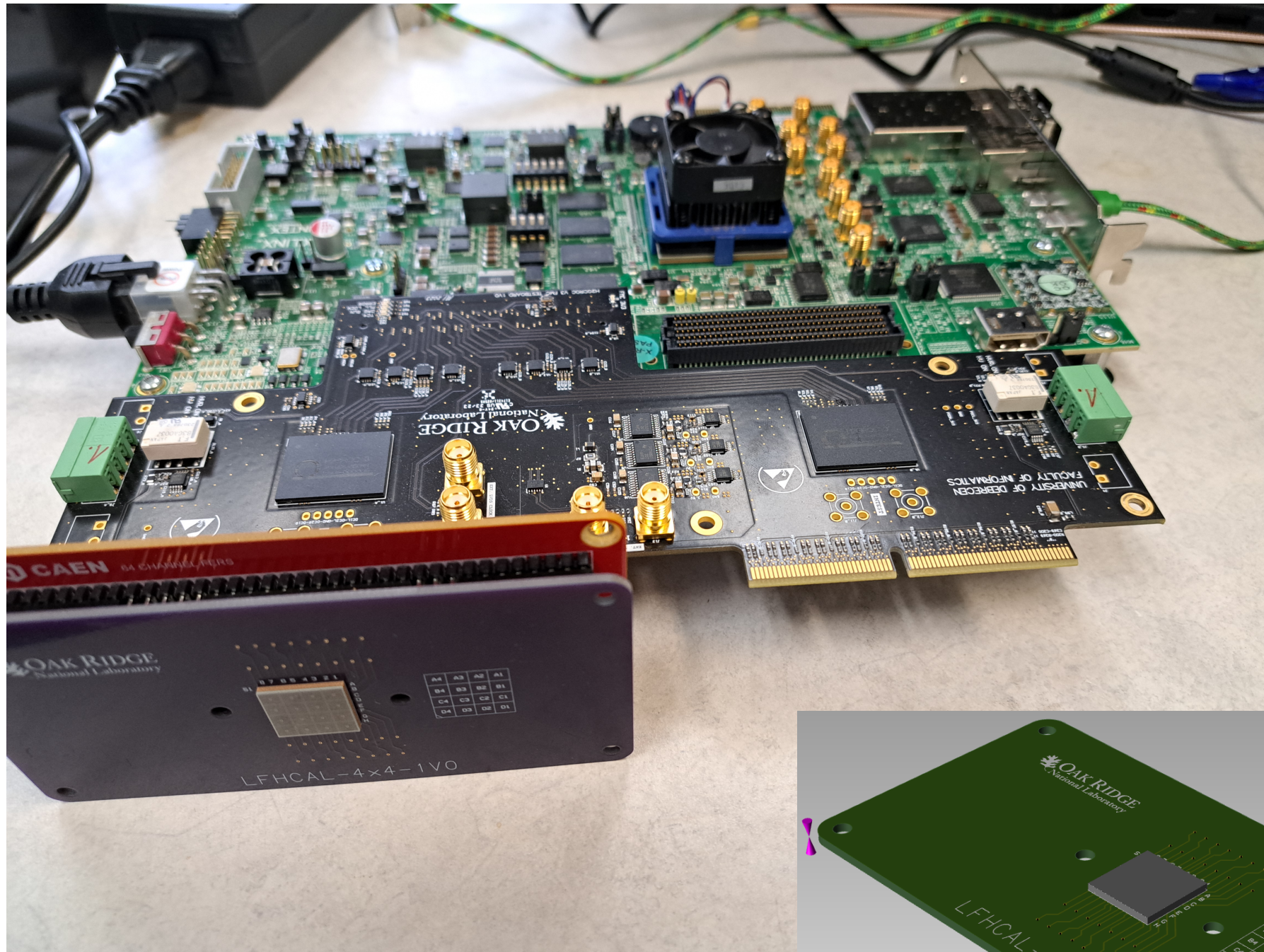
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Side View for EOSB (12 modules/9 chips scenario)



Cross section at SiPM Board





Testing soon at ORNL!

GlueX-BCAL SiPM & Electronics

Heat output

- From Fernando (2/19/2024): “SiPMs produce negligible heat but the bias distribution network does, still not anything comparable to what the preamps produce. Power consumption per wedge is less than 8 W. 400 W at each BCAL end.”
- From Tim (2/19/2024): “Each chiller is 1KW (1 at each end). There are 2 wedges in series (24 parallel circuits) and the temperature rise of the water is about 0.5C from inlet to outlet. Bias is adjusted for this”.
- HGCROC and AstroPIX contributions to heat (not in this talk).

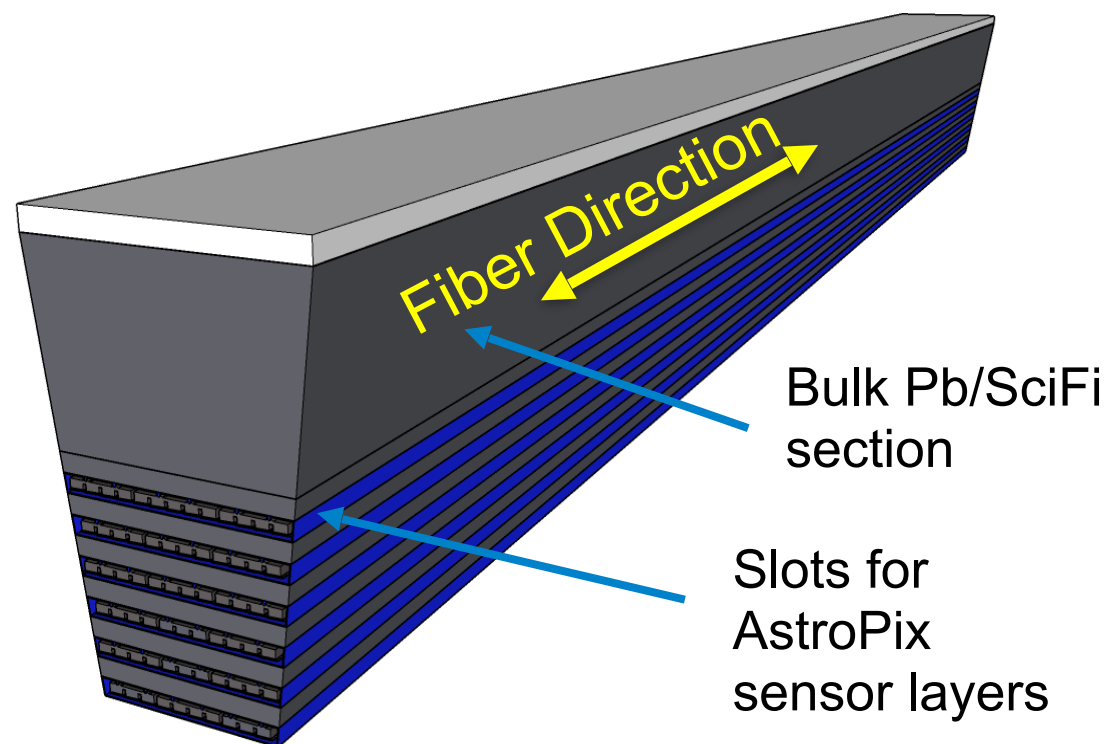
Summary

- **BIC baseline comparison is to GlueX/BCAL**
 - BIC is longer (435 cm vs 390 cm)
- Design, R&D, First Article
 - PbSciFi @ ANL & Manitoba
 - **ESB @ Regina** (UofA-MRS, ANL, ORNL)
 - PED Funds: Mech Eng / Elec Eng, Postdoc, M&S
 - Timeline: ~ 15 mo for test article (June 2025).

Backup slides

bECAL Sector

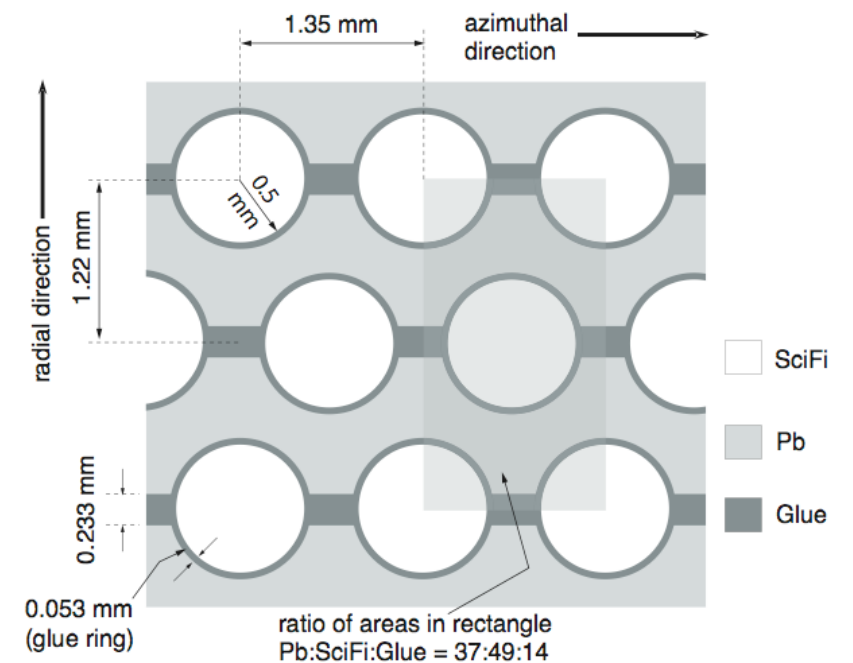
Calorimeter Sector



- 48 sectors:



- Bulk
- SFIL & ESB



- Inner: interleaved layers of imaging Si sensors with PbSciFi (SFIL- SciFi Imaging Layers)
- Outer: bulk Pb/SciFi section
- Light guides; optical cookie
- SiPMs as sensors

GlueX/BIC SiPMs

HAMAMATSU
PHOTON IS OUR BUSINESS

S14161-3050HS-04

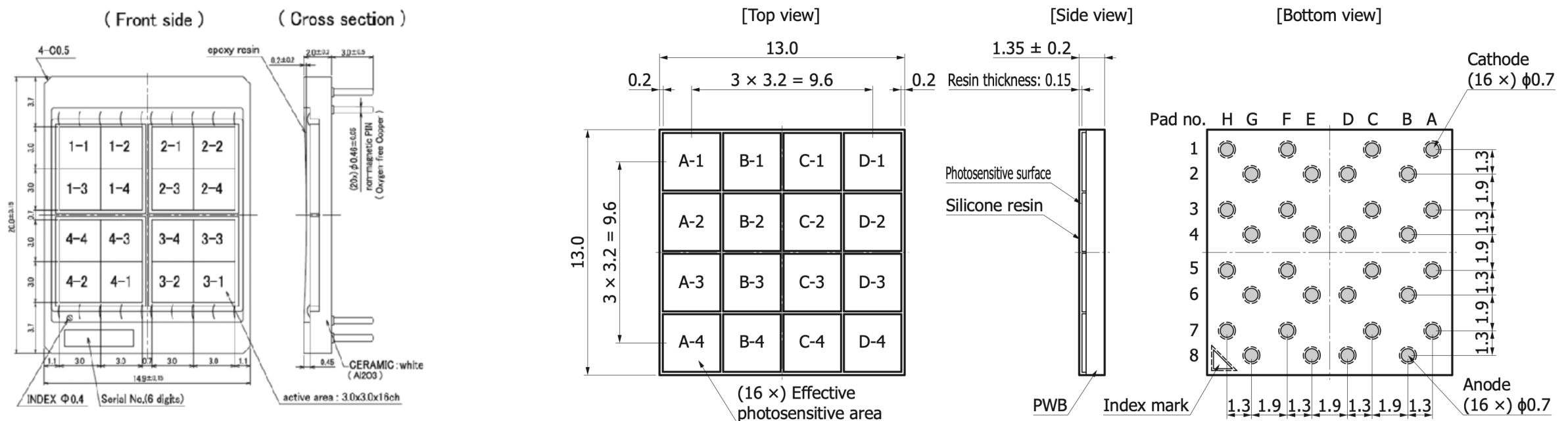


Fig. 1. A schematic drawing of the front and side views for the Hamamatsu MPPCs for the GlueX experiment is shown, detailing the tiling of the $3 \times 3 \text{ mm}^2$ cells into a 4×4 configuration. The numbered cells are active; all other areas and spacings are inactive. (Courtesy of Hamamatsu).

GlueX

BIC



University
of Regina

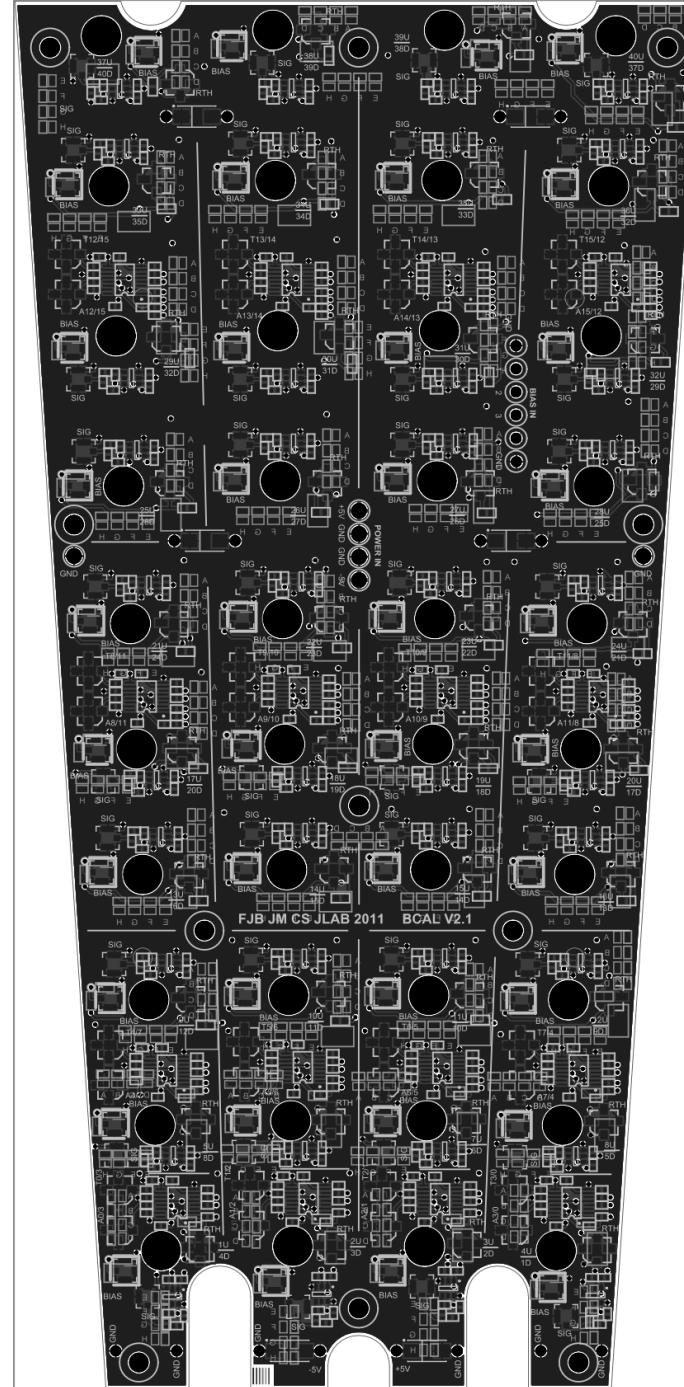
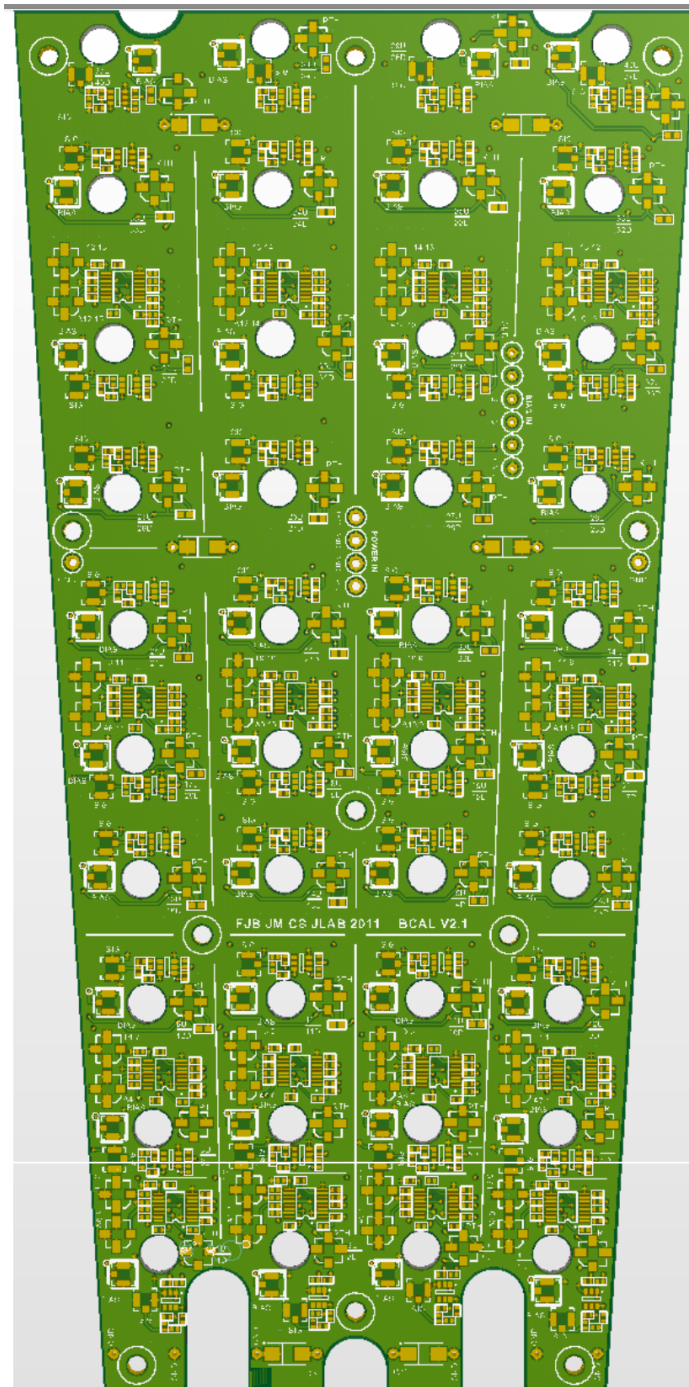


Faculty of
Science



NSERC
CRSNG

GlueX-BCAL Boards



← Analog/
Discrete

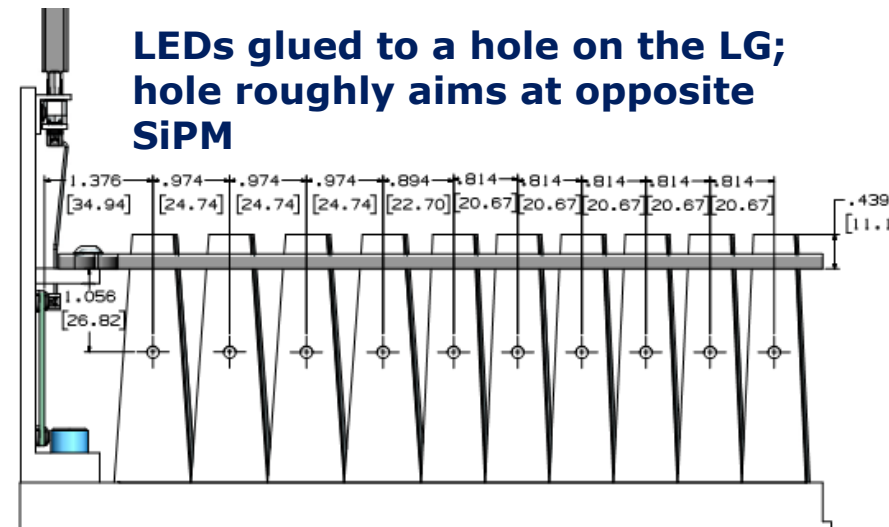
See Norbert's
talk on how
this will be done
for BIC/EIC

GlueX LMS

innermost LG 21x21 mm², outermost 27x25 mm²; output faces are 13x13 mm² to match SiPM window

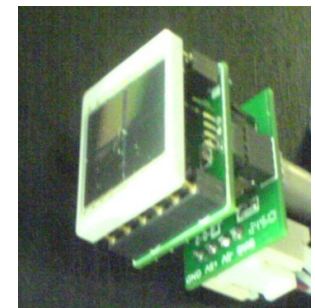
LEDs: Bivar, Blue, 465 nm

**LEDs glued to a hole on the LG;
hole roughly aims at opposite
SiPM**

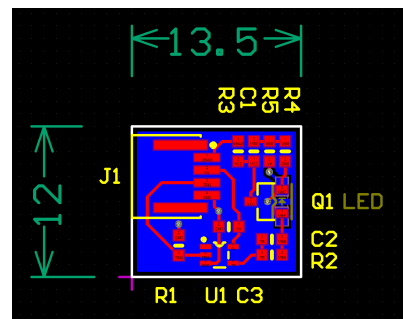


BCAL has 3840 SiPMs,
and
3840 LEDs: pulsing both
ends decouples SiPM from
LED failure

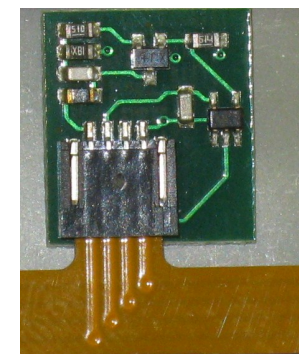
Hamamatsu S12045X



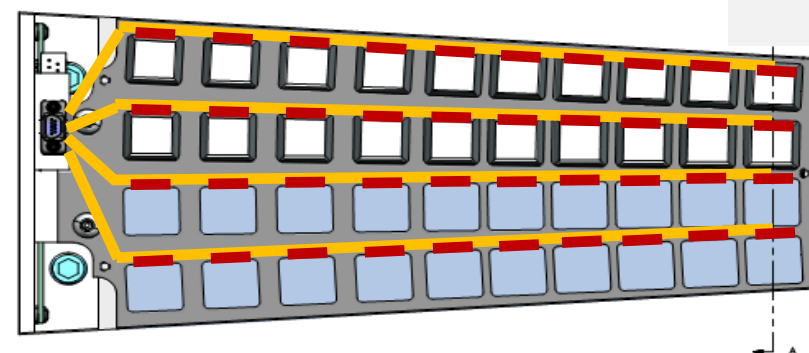
**BCAL miniboard
layout
("components"
side, LED on the
other side,
shining parallel to
the board
towards the
right)**



BCAL miniboard on flex cable



**4 flexible strips per side per
module**



BCAL Controller layout

